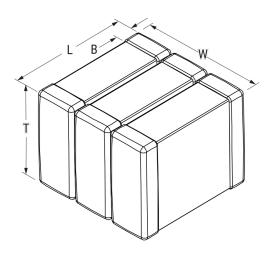


## CKC21C104KDGLC7805

KONNEKT KC-LINK Comm COG, Ceramic, 0.1 uF, 10%, 1000 VDC, COG, 3-Chip Low Loss Orientation.



Dimensions		 
L	5.7mm +/-0.4mm	
W	7.7mm +/-0.6mm	
Т	5mm +/-0.4mm	
В	0.6mm +/-0.35mm	

Packaging Specifications			
Packaging	T&R, 180mm		
Packaging Quantity	160		

General Information		
Series	KONNEKT KC-LINK Comm COG	
Style	KONNEKT	
Description	KC-LINK with KONNEKT, SMD, MLCC, Ultra- Stable, Class I	
Features	Ultra-Stable	
RoHS	Yes	
Termination	Tin	
AEC-Q200	No	
Component Weight	1g	
Notes	3-Chip Low Loss Orientation.	
Chip Size	2220-3	
MSL	1	

Specifications	
Capacitance	0.1 uF
Measurement Condition	1 kHz 1.0Vrms
Capacitance Tolerance	10%
Voltage DC	1000 VDC
Dielectric Withstanding Voltage	1200 VDC
Temperature Range	-55/+150°C
Temperature Coefficient	COG
Capacitance Change with Reference to +25°C and 0 VDC Applied (TCC)	30 ppm/C, 1kHz 1.0Vrms
Dissipation Factor	0.1% 1 kHz 1.0Vrms
Aging Rate	0% Loss/Decade Hour
Insulation Resistance	10 MOhms

Statements of suitability for certain applications are based on our knowledge of typical operating conditions for such applications, but are not intended to constitute - and we specifically disclaim - any warranty concerning suitability for a specific customer application or use. This Information is intended for use only by customers who have the requisite experience and capability to determine the correct products for their application. Any technical advice inferred from this Information or otherwise provided by us with reference to the use of our products is given gratis, and we assume no obligation or liability for the advice given or results obtained.

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